# **DISCRETE SEMICONDUCTORS**

# DATA SHEET

# **PDTA114T series** PNP resistor-equipped transistors; R1 = 10 k $\Omega$ , R2 = open

Product specification Supersedes data of 2003 Sep 09 2004 Aug 02





## PDTA114T series

#### **FEATURES**

- Built-in bias resistors
- · Simplified circuit design
- Reduction of component count
- Reduced pick and place costs.

#### **APPLICATIONS**

- · General purpose switching and amplification
- · Inverter and interface circuits
- · Circuit driver.

#### **QUICK REFERENCE DATA**

SYMBOL	PARAMETER	TYP.	MAX.	UNIT
V <sub>CEO</sub>	collector-emitter voltage	_	-50	V
I <sub>O</sub>	output current (DC)	_	-100	mA
R1	bias resistor	10	_	kΩ
R2	open	_	_	_

#### **DESCRIPTION**

PNP resistor-equipped transistor (see "Simplified outline, symbol and pinning" for package details).

#### **PRODUCT OVERVIEW**

TYPE NUMBER	PACE	KAGE	MARKING CODE	NPN COMPLEMENT
I TPE NUMBER	PHILIPS	EIAJ	WARKING CODE	NPN COMPLEMENT
PDTA114TE	SOT416	SC-75	11	PDTC114TE
PDTA114TEF	SOT490	SC-89	46	PDTC114TEF
PDTA114TK	SOT346	SC-59	23	PDTC114TK
PDTA114TM	SOT883	SC-101	DE	PDTC114TM
PDTA114TS	SOT54 (TO-92)	SC-43	TA114T	PDTC114TS
PDTA114TT	SOT23	_	*11 <sup>(1)</sup>	PDTC114TT
PDTA114TU	SOT323	SC-70	*23 <sup>(1)</sup>	PDTC114TU

#### Note

<sup>1. \* =</sup> p: Made in Hong Kong.

<sup>\* =</sup> t: Made in Malaysia.

<sup>\* =</sup> W: Made in China.

# PNP resistor-equipped transistors; R1 = 10 k $\Omega$ , R2 = open

# PDTA114T series

## SIMPLIFIED OUTLINE, SYMBOL AND PINNING

TYPE NUMBER	CIMPLIFIED OUTLINE AND CVMDOL		PINNING		
TYPE NUMBER	SIMPLIFIED OUTLINE AND SYMBOL	PIN	DESCRIPTION		
PDTA114TS	1 2 1 R1 3 3 MAM352	1 2 3	base collector emitter		
PDTA114TE PDTA114TEF PDTA114TK PDTA114TT PDTA114TU	3 1 R1 3 1 Top view MDB272	1 2 3	base emitter collector		
PDTA114TM	2 R1 3 1 Bottom view  MDB268	1 2 3	base emitter collector		

# PNP resistor-equipped transistors; R1 = 10 k $\Omega$ , R2 = open

## PDTA114T series

#### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>CBO</sub>	collector-base voltage	open emitter	_	-50	V
V <sub>CEO</sub>	collector-emitter voltage	open base	_	-50	V
V <sub>EBO</sub>	emitter-base voltage	open collector	_	<b>-</b> 5	V
Io	output current (DC)		_	-100	mA
I <sub>CM</sub>	peak collector current		_	-100	mA
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C			
	SOT54	note 1	_	500	mW
	SOT23	note 1	_	250	mW
	SOT346	note 1	_	250	mW
	SOT323	note 1	_	200	mW
	SOT416	note 1	_	150	mW
	SOT883	notes 2 and 3	_	250	mW
	SOT490	notes 1 and 2	_	250	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T <sub>amb</sub>	operating ambient temperature		-65	+150	°C

#### Notes

- 1. Refer to standard mounting conditions.
- 2. Reflow soldering is the only recommended soldering method.
- 3. Refer to SOT883 standard mounting conditions; FR4 with 60 µm copper strip line.

#### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th j-a</sub>	thermal resistance from junction to ambient	in free air		
	SOT54	note 1	250	K/W
	SOT23	note 1	500	K/W
	SOT346	note 1	500	K/W
	SOT323	note 1	625	K/W
	SOT416	note 1	833	K/W
	SOT883	notes 2 and 3	500	K/W
	SOT490	notes 1 and 2	500	K/W

#### Notes

- 1. Refer to standard mounting conditions.
- 2. Reflow soldering is the only recommended soldering method.
- 3. Refer to SOT883 standard mounting conditions; FR4 with 60  $\mu$ m copper strip line.

# PNP resistor-equipped transistors; R1 = 10 k $\Omega$ , R2 = open

# PDTA114T series

#### **CHARACTERISTICS**

 $T_{amb}$  = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I <sub>CBO</sub>	collector-base cut-off current	$V_{CB} = -50 \text{ V}; I_E = 0$	_	_	-100	nA
I <sub>CEO</sub>	collector-emitter cut-off current	$V_{CE} = -30 \text{ V}; I_{B} = 0$	_	_	-1	μΑ
		$V_{CE} = -30 \text{ V}; I_B = 0; T_j = 150 ^{\circ}\text{C}$	_	_	-50	μΑ
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; I_C = 0$	_	_	-100	nA
h <sub>FE</sub>	DC current gain	$V_{CE} = -5 \text{ V}; I_{C} = -1 \text{ mA}$	200	_	_	
V <sub>CEsat</sub>	collector-emitter saturation voltage	$I_C = -10 \text{ mA}; I_B = -0.5 \text{ mA}$	_	_	-150	mV
R1	input resistor		7	10	13	kΩ
C <sub>c</sub>	collector capacitance	$I_E = i_e = 0$ ; $V_{CB} = -10 \text{ V}$ ; $f = 1 \text{ MHz}$	_	_	3	pF

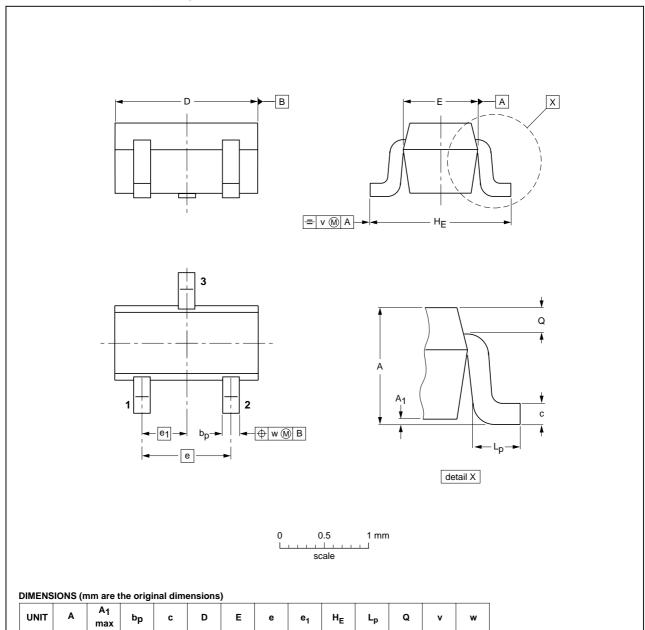
# PNP resistor-equipped transistors; R1 = 10 k $\Omega$ , R2 = open

## PDTA114T series

#### **PACKAGE OUTLINES**

## Plastic surface mounted package; 3 leads

**SOT416** 



OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE	
SOT416			SC-75		97-02-28	

1.75

1.45

1

0.5

0.45

0.23

0.2

0.2

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0.30

0.15

0.95

0.60

0.1

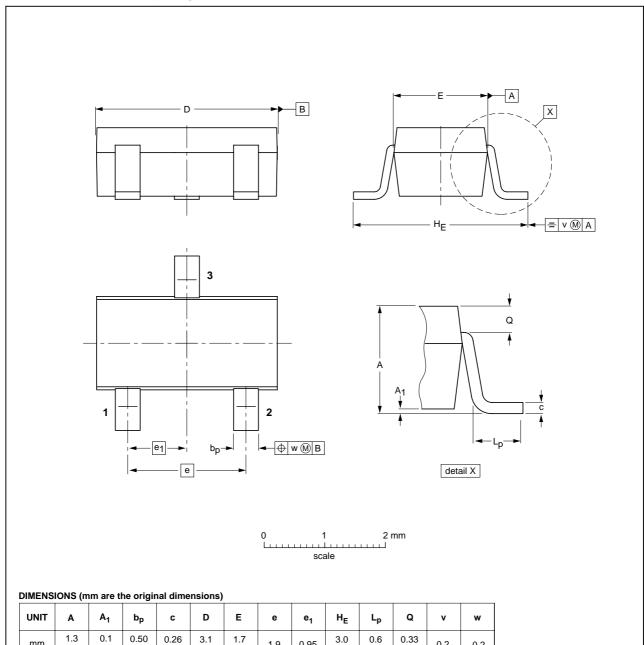
0.25

0.10

## PDTA114T series

## Plastic surface mounted package; 3 leads

**SOT346** 



OUTLINE	REFERENCES			REFERENCES EUROPEAN		
VERSION	IEC	JEDEC EIAJ PRO		PROJECTION	ISSUE DATE	
SOT346		TO-236	SC-59			98-07-17

0.95

0.2

0.2

1.9

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1.0

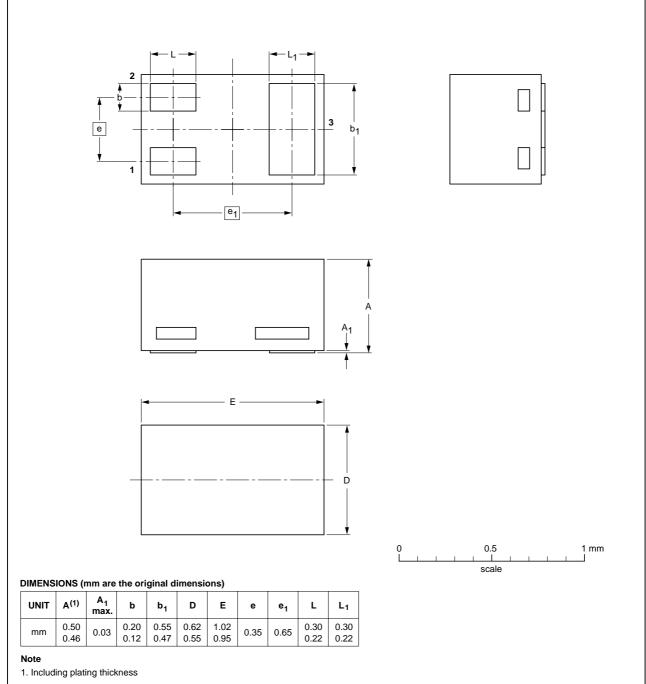
0.013

# PNP resistor-equipped transistors; R1 = 10 k $\Omega$ , R2 = open

## PDTA114T series

## Leadless ultra small plastic package; 3 solder lands; body 1.0 x 0.6 x 0.5 mm

**SOT883** 



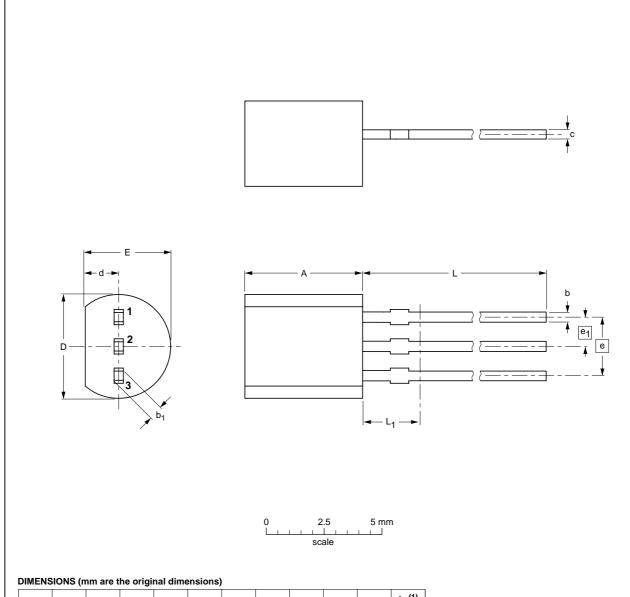
OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT883			SC-101		<del>03-02-05</del> 03-04-03

# PNP resistor-equipped transistors; R1 = 10 k $\Omega$ , R2 = open

## PDTA114T series

## Plastic single-ended leaded (through hole) package; 3 leads

SOT54



UNIT	A	b	b <sub>1</sub>	С	D	d	E	е	e <sub>1</sub>	L	L <sub>1</sub> <sup>(1)</sup> max.
mm	5.2 5.0	0.48 0.40	0.66 0.55	0.45 0.38	4.8 4.4	1.7 1.4	4.2 3.6	2.54	1.27	14.5 12.7	2.5

#### Note

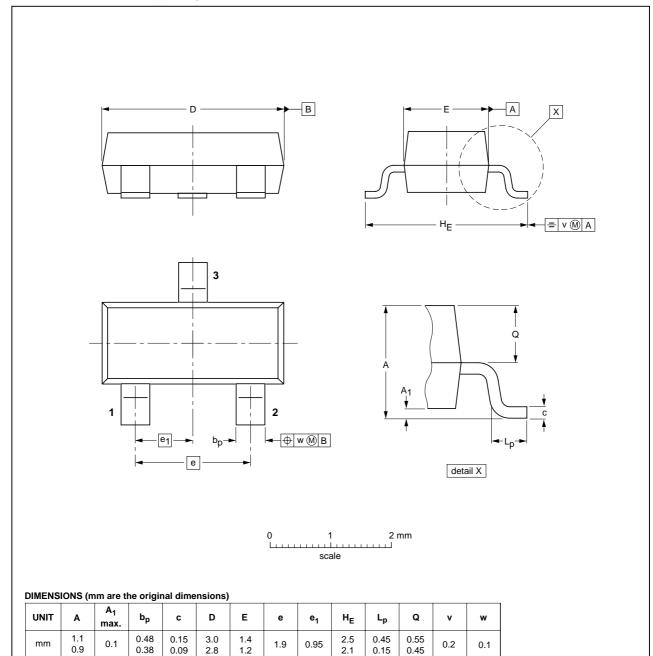
1. Terminal dimensions within this zone are uncontrolled to allow for flow of plastic and terminal irregularities.

OUTLINE		REFER	ENCES		EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA	PROJECTION		ISSUE DATE	
SOT54		TO-92	SC-43A			<del>97-02-28</del> 04-06-28	

## PDTA114T series

## Plastic surface mounted package; 3 leads

SOT23

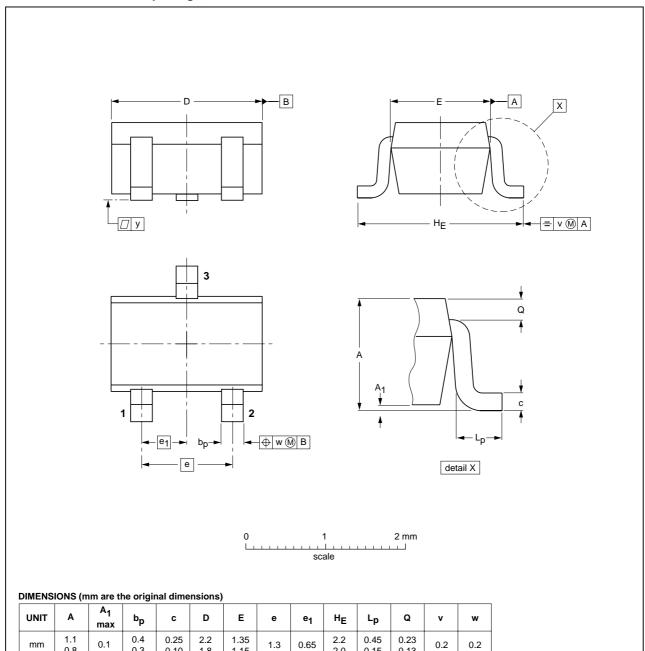


OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC JEDEC E		EIAJ	PROJECTION	ISSUE DATE	
SOT23		TO-236AB			<del>-97-02-28-</del> 99-09-13	

## PDTA114T series

## Plastic surface mounted package; 3 leads

**SOT323** 



OUTLINE VERSION	REFERENCES				EUROPEAN	ISSUE DATE
	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT323			SC-70			97-02-28

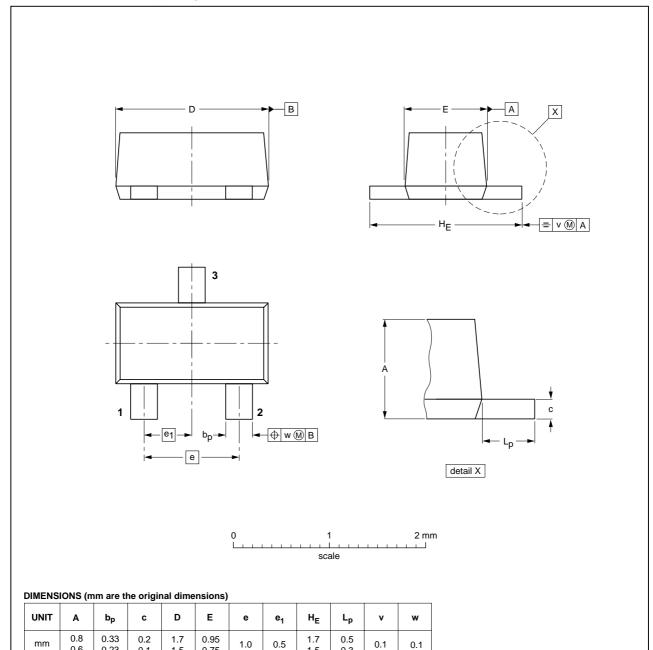
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0.3

## PDTA114T series

## Plastic surface mounted package; 3 leads

**SOT490** 



OUTLINE VERSION	REFERENCES				EUROPEAN	ISSUE DATE
	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT490			SC-89		$\bigoplus \bigoplus$	98-10-23

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0.6

# PNP resistor-equipped transistors; R1 = 10 k $\Omega$ , R2 = open

## PDTA114T series

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LEVEL	DATA SHEET STATUS	PRODUCT STATUS <sup>(2)(3)</sup>	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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